

Features

- * Ideal for printed circuit board
- * Reliable low cost construction utilizing molded plastic technique
- * High surge current capability
- * Polarity: marked on body
- * Mounting position: Any

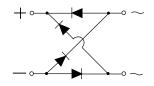


DBS

Package Marking and Ordering Information

| Product ID | Pack | Marking | Qty(PCS) | | |
|---------------|------|---------|----------|--|--|
| DB301S-DB307S | DBS | DB30xS | 1500 | | |





Internal Structure

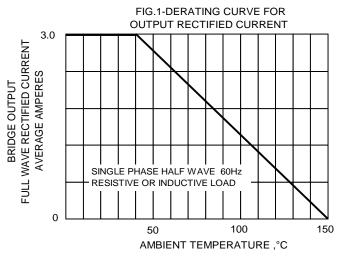
Maximum Ratings (Ta=25°C unless otherwise noted) Single phase half wave, 60Hz, resistive or inductive load.

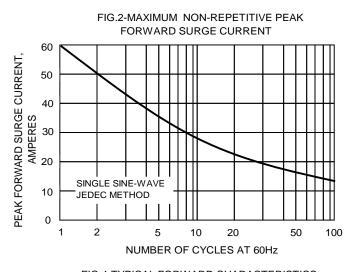
For capacitive load, derate current by 20%.

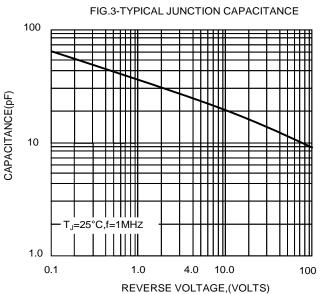
| CHARACTERISTICS | SYMBOL | DB301S | DB302S | DB303S | DB304S | DB305S | DB306S | DB307S | UNIT |
|--|------------------|-------------|--------|--------|--------|--------|--------|--------------|--------|
| Maximum Recurrent Peak Reverse Voltage | VRRM | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS Voltage | VRMS | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | VDC | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum Average Forward Rectified Current @Ta=40℃ | I(AV) | 3.0 | | | | | | | Α |
| Peak Forward Surge Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC .Method) | lғsм | 60 | | | | | | | А |
| Maximum Forward Voltage at 2.0A DC | VF | 1.1 | | | | | | V | |
| Maximum DC Reverse Current @TJ=25℃ at Rated DC Blocking Voltage @TJ=125℃ | lR | 10 500 | | | | | | | μΑ |
| I ² t Rating for Fusing (t<8.3ms) | l ² t | 10.4 | | | | | | | A^2s |
| Typical Junction capacitance Per Element(Note1) | Cı | 25 | | | | | | | pF |
| Typical Thermal Resistance (Note2) | RөJA | 40 | | | | | °C/W | | |
| Operating Temperature Range | TJ | -55 to +150 | | | | | | $^{\circ}$ C | |
| Storage Temperature Range | Tstg | -55 to +150 | | | | | | $^{\circ}$ C | |

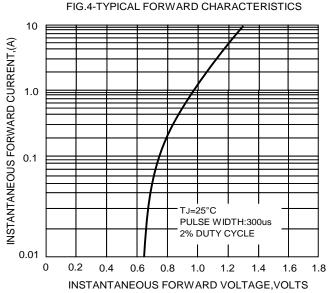


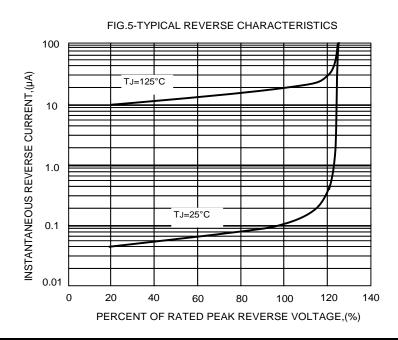
Typical Characteristics



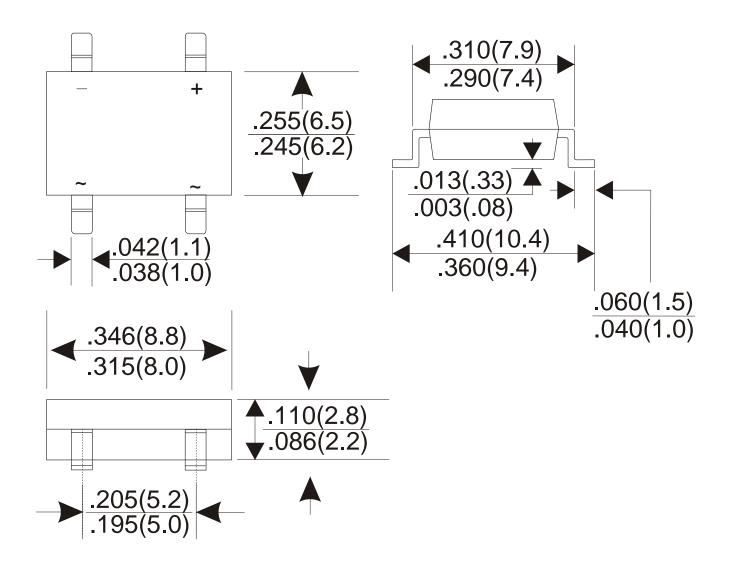








DBS Package Outline Dimensions



Dimensions in inches and (millimeters)



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